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IP3253/IP3254-TTL

Integrated 4-, 6- and 8-channel passive EMI-filter network with high-level ESD protection

Rev. 1 — 5 May 2011

Product data sheet

1. Product profile

1.1 General description

The IP3253/IP3254-TTL family consists of 4-, 6- and 8-channel LC low-pass filter arrays designed to filter unwanted RF signals on the I/O ports of portable communication and computing devices. In addition, the IP3253/IP3254-TTL family incorporates diodes which protect downstream components from ElectroStatic Discharge (ESD) voltages up to ± 15 kV.

These devices are fabricated using monolithic silicon technology integrating up to 8 inductors and 16 diodes in a 0.4 mm pitch 8-, 12- or 16-pin ultra-thin leadless Quad Flat No-leads (QFN) plastic package.

1.2 Features and benefits

- Pb-free, Restriction of Hazardous Substances (RoHS) compliant and free of halogen and antimony (Dark Green compliant)
- 4-, 6- and 8-channel integrated π-type LC filter network
- ESD protection to ±15 kV contact discharge according to IEC 61000-4-2, level 4
- ESD protection to ±30 kV contact discharge according to MIL-STD-883 (method 3015)
 Human Body Model (HBM)
- QFN plastic package with 0.4 mm pitch and 0.5 mm height

1.3 Applications

- General-purpose ElectroMagnetic Interference (EMI), Radio-Frequency Interference (RFI) filtering and downstream ESD protection for:
 - ◆ Cellular phone and Personal Communication System (PCS) mobile handsets
 - Cordless telephones
 - Wireless data (WAN/LAN) systems



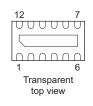
2. Pinning information

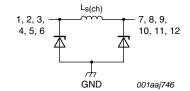
Table 1. Pinning

Pin	Description	Simplified outline	Graphic symbol
IP3253CZ8-	4-TTL; IP3254C	Z8-4-TTL (SOT1166-1)	
1 and 8	filter channel 1		
2 and 7	filter channel 2	- 8 5 [UUUU]	L _{s(ch)} 1, 2, 3, 4 + 5, 6, 7, 8
3 and 6	filter channel 3		+
4 and 5	filter channel 4	1 4	T T
ground pad	ground	Transparent top view	/ // GND 001aaj745

IP3253CZ12-6-TTL; IP3254CZ12-6-TTL (SOT1167-1)

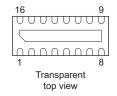
1 and 12	filter channel 1
2 and 11	filter channel 2
3 and 10	filter channel 3
4 and 9	filter channel 4
5 and 8	filter channel 5
6 and 7	filter channel 6
ground pad	ground

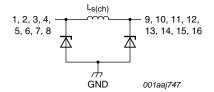




IP3253CZ16-8-TTL; IP3254CZ16-8-TTL (SOT1168-1)

1 and 16	filter channel 1
2 and 15	filter channel 2
3 and 14	filter channel 3
4 and 13	filter channel 4
5 and 12	filter channel 5
6 and 11	filter channel 6
7 and 10	filter channel 7
8 and 9	filter channel 8
ground pad	ground





3. Ordering information

Table 2. Ordering information

Type number	Package					
	Name	Description	Version			
IP3253CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 \times 1.7 \times 0.55 mm	SOT1166-1			
IP3253CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 \times 2.5 \times 0.55 mm	SOT1167-1			
IP3253CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 \times 3.3 \times 0.55 mm	SOT1168-1			
IP3254CZ8-4-TTL	HUSON8	plastic, thermal enhanced ultra thin small outline package; no leads; 8 terminals; body 1.35 \times 1.7 \times 0.55 mm	SOT1166-1			
IP3254CZ12-6-TTL	HUSON12	plastic, thermal enhanced ultra thin small outline package; no leads; 12 terminals; body 1.35 \times 2.5 \times 0.55 mm	SOT1167-1			
IP3254CZ16-8-TTL	HUSON16	plastic, thermal enhanced ultra thin small outline package; no leads; 16 terminals; body 1.35 \times 3.3 \times 0.55 mm	SOT1168-1			

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		,				
Symbol	Parameter	Conditions	М	in	Max	Unit
V_{CC}	supply voltage		-().5	+5.6	V
V_{ESD}	electrostatic discharge voltage	all pins to ground; contact discharge				
		HBM; MIL-STD-883, method 3015	-		±30	kV
		IEC 61000-4-2, level 4	<u>[1]</u> _		±15	kV
I _{ch}	channel current (DC)	T _{amb} = 85 °C	-		30	mA
P _{ch}	channel power dissipation		-		10	mW
P _{tot} /pack	total power dissipation per package	T _{amb} = 85 °C	-		500	mW
T _{stg}	storage temperature		-6	65	+150	°C
T _{amb}	ambient temperature		_4	10	+85	°C

^[1] Device tested with 1000 pulses of ±15 kV contact discharges, according to the IEC 61000-4-2 model, far exceeding IEC 61000-4-2 level 4 (8 kV contact discharge).

5. Characteristics

Table 4. Channel characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
L _{s(ch)}	channel series inductance		-	18	-	nΗ
C_{ch}	channel capacitance	for the total channel; $f_i = 100 \text{ kHz}$	<u>[1]</u>			
	IP3253CZx-y-TTL	$V_{\text{bias}(DC)} = 2.5 \text{ V}$	20	25	28.2	pF
		$V_{bias(DC)} = 0 V$	34	43	48	pF
	IP3254CZx-y-TTL	$V_{\text{bias}(DC)} = 2.5 \text{ V}$	25	33	40	pF
		$V_{\text{bias}(DC)} = 0 \text{ V}$	38	50	60	pF
I_{LR}	reverse leakage current	per channel; V _I = 3.5 V	-	-	0.1	μΑ
V_{BR}	breakdown voltage	positive clamp; I _I = 1 mA	5.8	-	10	V
V _F	forward voltage	negative clamp; I _F = -1 mA	-1.5	-	-0.4	V
R _(ch-ch)	resistance between channels	$V_1 = 3.5 \text{ V}$	10	-	-	$M\Omega$
R _{s(ch)}	channel series resistance		-	8	-	Ω

^[1] Guaranteed by design.

Table 5. Frequency characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Parameter	Conditions	Min	Тур	Max	Unit
insertion loss	R_{source} = 50 Ω ; R_{L} = 50 Ω ; 1 GHz < f_{i} < 4 GHz	-	30	-	dB
cut-off frequency	R_{source} = 50 Ω ; R_L = 50 Ω ; V_I = 0 V				
IP3253CZx-y-TTL		-	175	-	MHz
IP3254CZx-y-TTL		-	145	-	MHz
roll-off frequency	R_{source} = 50 Ω ; R_L = 50 Ω ; V_I = 0 V	[1]			
IP3253CZx-y-TTL		-	350	-	MHz
IP3254CZx-y-TTL		-	315	-	MHz
	insertion loss cut-off frequency IP3253CZx-y-TTL IP3254CZx-y-TTL roll-off frequency IP3253CZx-y-TTL	$\begin{array}{ll} \text{insertion loss} & R_{source} = 50 \ \Omega; \ R_L = 50 \ \Omega; \\ 1 \ \text{GHz} < f_i < 4 \ \text{GHz} \end{array}$ $\text{cut-off frequency} & R_{source} = 50 \ \Omega; \ R_L = 50 \ \Omega; \\ V_I = 0 \ V \\ \text{IP3253CZx-y-TTL} \\ \text{IP3254CZx-y-TTL} \\ \text{roll-off frequency} & R_{source} = 50 \ \Omega; \ R_L = 50 \ \Omega; \\ V_I = 0 \ V \\ \text{IP3253CZx-y-TTL} \end{array}$	$\begin{array}{ll} \text{insertion loss} & R_{\text{source}} = 50 \ \Omega; \ R_{\text{L}} = 50 \ \Omega; \\ 1 \ \text{GHz} < f_{\text{I}} < 4 \ \text{GHz} \end{array} \qquad -$ $\text{cut-off frequency} & R_{\text{source}} = 50 \ \Omega; \ R_{\text{L}} = 50 \ \Omega; \\ V_{\text{I}} = 0 \ V \\ \\ \text{IP3253CZx-y-TTL} & - \\ \text{roll-off frequency} & R_{\text{source}} = 50 \ \Omega; \ R_{\text{L}} = 50 \ \Omega; \\ V_{\text{I}} = 0 \ V \\ \\ \text{IP3253CZx-y-TTL} & - \\ \end{array}$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$\begin{array}{llllllllllllllllllllllllllllllllllll$

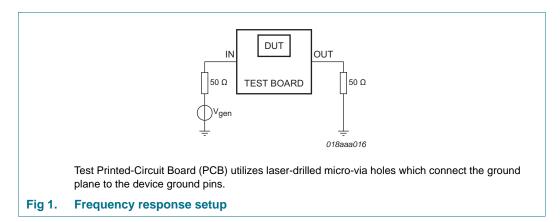
^[1] Measured at 6 dB attenuation.

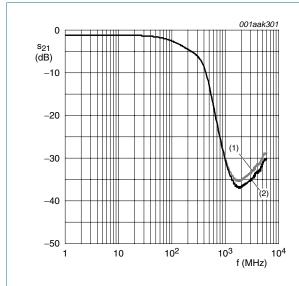
6. Application information

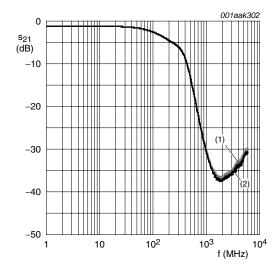
6.1 Insertion loss

The devices are specifically designed as EMI/RFI filters for multichannel interfaces.

The block schematic for measuring insertion loss in a 50 Ω system is shown in Figure 1. An example of the measurement curves for all channels is shown in Figure 2.



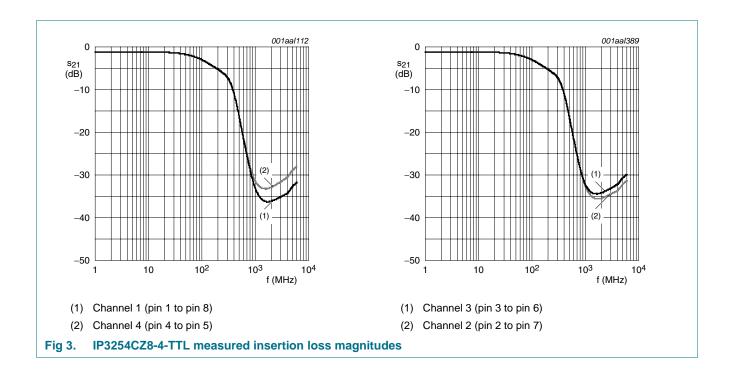




- (1) Channel 1 (pin 1 to pin 8)
- (2) Channel 4 (pin 4 to pin 5)

- (1) Channel 3 (pin 3 to pin 6)
- (2) Channel 2 (pin 2 to pin 7)

Fig 2. IP3253CZ8-4-TTL measured insertion loss magnitudes



6 of 13

7. Package outline

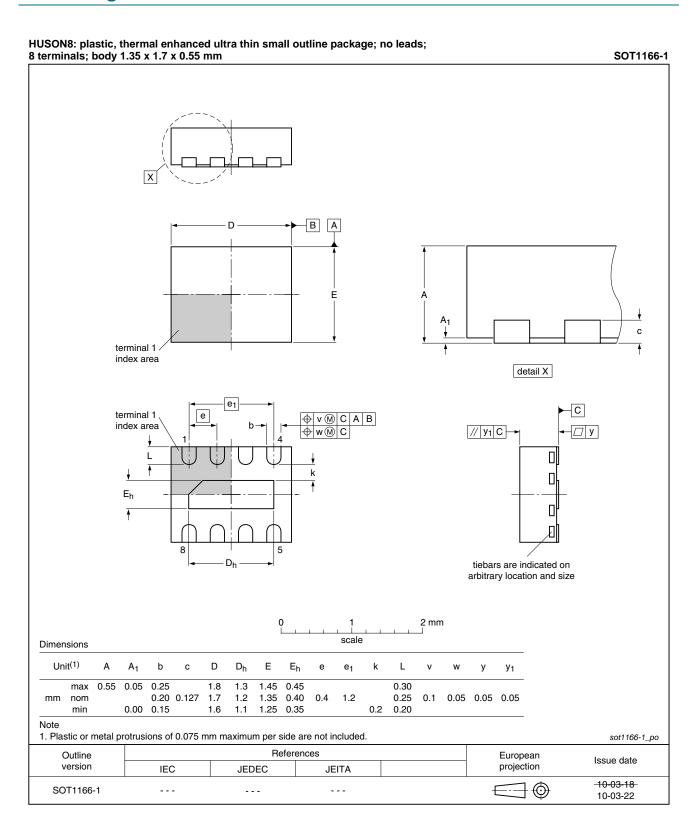


Fig 4. Package outline SOT1166-1 (HUSON8)

IP3253_IP3254-TTL

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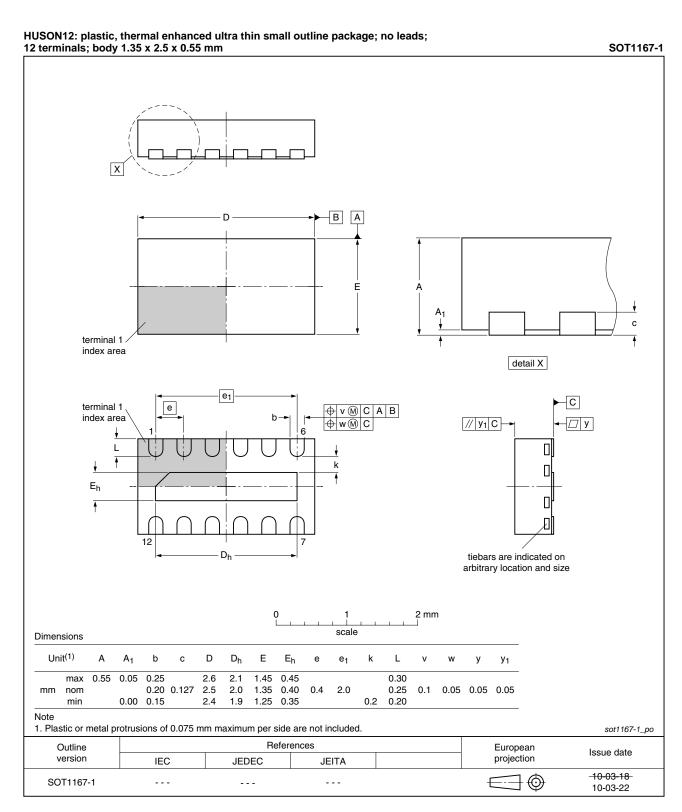


Fig 5. Package outline SOT1167-1 (HUSON12)

IP3253_IP3254-TTL

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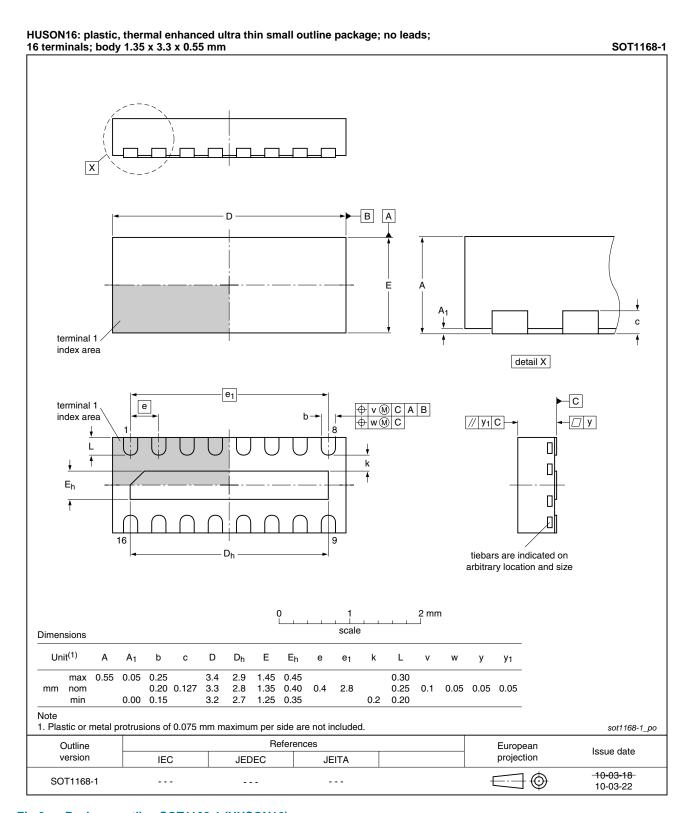


Fig 6. Package outline SOT1168-1 (HUSON16)

8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
IP3253_IP3254-TTL v.1	20110505	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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IP3253 IP3254-TTL

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IP3253/IP3254-TTL

Integrated 4-, 6- and 8-channel passive EMI-filter network

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Product data sheet

11. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
2	Pinning information 2
3	Ordering information 3
4	Limiting values 3
5	Characteristics4
6	Application information 5
6.1	Insertion loss 5
7	Package outline
8	Revision history
9	Legal information11
9.1	Data sheet status
9.2	Definitions11
9.3	Disclaimers
9.4	Trademarks
10	Contact information
11	Contents 13

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